LM4926 Ground-Referenced, Ultra Low Noise, Fixed Gain, 80mW Stereo

Headphone Amplifier



Literature Number: SNAS266B



OBSOLETE October 3, 2011

1.5V/V (typ)

1.6V to 4.2V

Boomer<sup>®</sup> Audio Power Amplifier Series

# Ground-Referenced, Ultra Low Noise, Fixed Gain, 80mW Stereo Headphone Amplifier

### **General Description**

The LM4926 is a ground referenced, fixed-gain audio power amplifier capable of delivering 80mW of continuous average power into a  $16\Omega$  single-ended load with less than 1% THD +N from a 3V power supply.

The LM4926 features a new circuit technology that utilizes a charge pump to generate a negative reference voltage. This allows the outputs to be biased about ground, thereby eliminating output-coupling capacitors typically used with normal single-ended loads.

The LM4926 features an Automatic Standby Mode circuitry (patent pending). In the absence of an input signal, after approximately 12 seconds, the LM4926 goes into low current standby mode. The LM4926 recovers into full power operating mode immediately after a signal is applied to either the left or right input pins. This feature saves power supply current in battery operated applications.

Boomer audio power amplifiers were designed specifically to provide high quality output power with a minimal amount of external components. The LM4926 does not require output coupling capacitors or bootstrap capacitors, and therefore is ideally suited for mobile phone and other low voltage applications where minimal power consumption is a primary requirement.

The LM4926 features a low-power consumption shutdown mode selectable for either channel separately. This is accomplished by driving either the SD\_RC (Shutdown Right Channel) or SD\_LC (Shutdown Left Channel) (or both) pins with logic low, depending on which channel is desired shutdown. Additionally, the LM4926 features an internal thermal shutdown protection mechanism.

The LM4926 contains advanced pop & click circuitry that eliminates noises which would otherwise occur during turn-on and turn-off transitions.

#### The LM4926 has an internal fixed gain of 1.5V/V.

# **Key Specifications**

- Improved PSRR at 217Hz 70dB (typ)
- Power Output at  $V_{DD} = 3V$ ,  $R_1 = 16\Omega$ , THD 1% 80mW (typ)
- $R_L = 16\Omega$ , THD1%80mW (typ)Shutdown Current0.01μA (typ)
- Internal Fixed Gain
  - Fixed Gain
- Operating Voltage

### **Features**

- Ground referenced outputs
- High PSRR
- Available in space-saving micro SMD package
- Ultra low current shutdown mode
- Improved pop & click circuitry eliminates noises during turn-on and turn-off transitions
- No output coupling capacitors, snubber networks, bootstrap capacitors, or gain-setting resistors required
- Shutdown either channel independently

### Applications

- Notebook PCs
- Mobile Phone
- PDAs
- Portable electronic devices
- MP3 Players

Boomer® is a registered trademark of National Semiconductor Corporation

© 2011 National Semiconductor Corporation 201161

# **Typical Application**

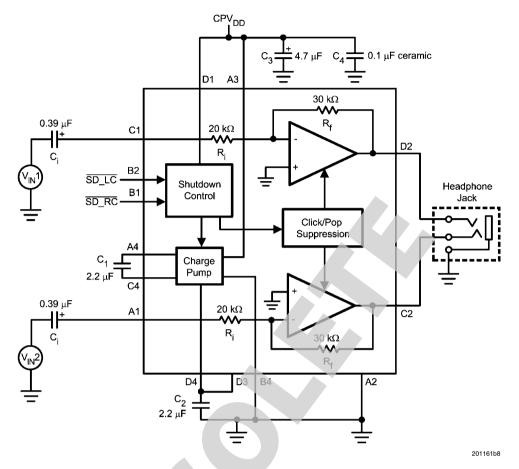
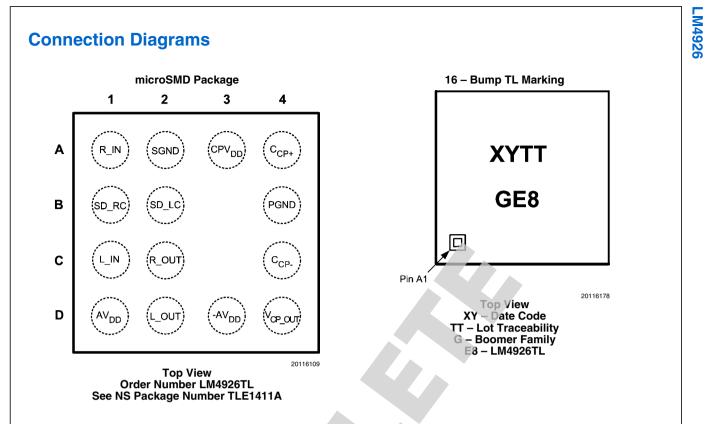


FIGURE 1. Typical Audio Amplifier Application Circuit



### **Pin Descriptions**

Pin	Name	Function
A1	R_IN	Right Channel Input
A2	SGND	Signal Ground
A3	CPV <sub>DD</sub>	Charge Pump Power Supply
A4	C <sub>CP+</sub>	Positive Terminal - Charge Pump Flying Capacitor
B1	SD_RC	Active-Low Shutdown, Right Channel
B2	SD_LC	Active-Low Shutdown, Left Channel
B4	PGND	Power Ground
C1	L_IN	Left Channel Input
C2	R_OUT	Right Channel Input
C4	C <sub>CP-</sub>	Negative Terminal - Charge Pump Flying Capacitor
D1	+AV <sub>DD</sub>	Positive Power Supply - Amplifier
D2	L_OUT	Left Channel Output
D3	-AV <sub>DD</sub>	Negative Power Supply - Amplifier
D4	V <sub>CP_OUT</sub>	Charge Pump Power Output

# Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage	4.5V
Storage Temperature	-65°C to +150°C
Input Voltage	-0.3V to V <sub>DD</sub> + 0.3V
Power Dissipation (Note 3)	Internally Limited
ESD Susceptibility (Note 4)	2000V
ESD Susceptibility (Note 5)	200V

Junction Temperature	150°C
Thermal Resistance	
θ <sub>JA</sub> (typ) TLE1411A (Note 11)	86°C/W

## **Operating Ratings**

Temperature Range	
$T_{MIN} \leq T_{A} \leq T_{MAX}$	$-40^{\circ}C \le T_A \le 85^{\circ}C$
Supply Voltage (V <sub>DD</sub> )	$1.6V \le V_{DD} \le 4.2V$

# Electrical Characteristics V<sub>DD</sub> = 3V (Note 1)

			LM4926			
Symbol	Parameter	Conditions	Typ (Note 6)	Limit ( <i>Note 7</i> ) ( <i>Note 8</i> )	Units (Limits)	
	Quiescent Power Supply Current Auto Standby Mode	V <sub>IN</sub> = 0V, inputs terminated both channels enabled	2.3		mA	
I <sub>DD</sub>	Quiescent Power Supply Current	V <sub>IN</sub> = 0V, inputs terminated both channels enabled	7	10	mA (max)	
	Full Power Mode	V <sub>IN</sub> = 0V, inputs terminated one channel enabled	5		mA	
I <sub>SD</sub>	Shutdown Current	$V_{SD_{LC}} = V_{SD_{RC}} = GND$	0.1	1.8	μA (max)	
V <sub>OS</sub>	Output Offset Voltage	$R_L = 32\Omega, V_{IN} = 0V$	0.7	5	mV (max)	
A <sub>V</sub>	Voltage Gain		-1.5		V/V	
ΔA <sub>V</sub>	Gain Match		1		%	
R <sub>IN</sub>	Input Resistance		20	15 25	$k\Omega$ (min) $k\Omega$ (max)	
	Output Power	THD+N = 1% (max); f = 1kHz, $R_{L} = 16\Omega$ , one channel	80		mW	
5		THD+N = 1% (max); f = 1kHz, R <sub>L</sub> = $32\Omega$ , one channel	65		mW	
Po		THD+N = 1% (max); f = 1kHz, R <sub>L</sub> = 16 $\Omega$ , (two channels in phase)	43	38	mW (min)	
		THD+N = 1% (max); f = 1kHz, R <sub>L</sub> = $32\Omega$ , (two channels in phase)	50	45	mW (min)	
	Total Harmonic Distortion +	$P_0 = 60$ mW, f = 1kHz, R <sub>L</sub> = 16 $\Omega$ single channel	0.04			
THD+N	Noise	$P_0 = 50$ mW, f = 1kHz, R <sub>L</sub> = 32 $\Omega$ single channel	0.03		- %	
		V <sub>RIPPLE</sub> = 200mVp-p, Input Referred	44		Į	
PSRR	Power Supply Rejection Ratio Full Power Mode	f = 217Hz	70			
ronn		f = 1kHz	65		dB	
		f = 20kHz	50			
SNR	Signal-to-Noise Ratio	$R_L = 32\Omega$ , $P_{OUT} = 20$ mW, (A-weighted) f = 1kHz, BW = 20Hz to 22kHz	100		dB	
V <sub>IH</sub>	Shutdown Input Voltage High		V <sub>IH</sub> = 0.7*CPV <sub>DD</sub>		v	
V <sub>IL</sub>	Shutdown Input Voltage Low		V <sub>IL</sub> = 0.3*CPV <sub>DD</sub>		V	

www.national.com

			LM	LM4926		
Symbol	Parameter	Conditions	Тур ( <i>Note 6</i> )	Limit ( <i>Note 7</i> ) ( <i>Note 8</i> )	Units (Limits)	
Τ <sub>WU</sub>	Wake Up Time From Shutdown		5		μs	
X <sub>TALK</sub>	Crosstalk	R <sub>L</sub> = 16Ω, P <sub>O</sub> = 1.6mW, f = 1kHz	60		dB	
Z <sub>OUT</sub>	Output Impedance	Input Terminated Input not terminated	∞ 60		kΩ	
IL	Input Leakage		±0.1		nA	
V <sub>IN THRESH</sub>	Input Voltage Threshold		2.8		mVp	

Note 1: All voltages are measured with respect to the GND pin unless otherwise specified.

Note 2: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional but do not guarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions that guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given; however, the typical value is a good indication of device performance.

**Note 3:** The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{JMAX}$ ,  $\theta_{JA}$ , and the ambient temperature,  $T_A$ . The maximum allowable power dissipation is  $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$  or the number given in Absolute Maximum Ratings, which ever is lower. For the LM4926, see power derating currents for more information.

Note 4: Human body model, 100pF discharged through a 1.5k $\!\Omega$  resistor.

Note 5: Machine Model, 220pF - 240pF discharged through all pins.

Note 6: Typicals are measured at 25°C and represent the parametric norm.

Note 7: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level)

Note 8: Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

**Note 9:** If the product is in shutdown mode and  $V_{DD}$  exceeds 4.2V (to a max of 4.5V  $V_{DD}$ ), then most of the excess current will flow through the ESD protection circuits. If the source impedance limits the current to a max of 10mA, then the part will be protected. If the part is enabled when  $V_{DD}$  is above 4.5V, circuit performance will be curtailed or the part may be permanently damaged.

Note 10: Human body model, 100pF discharged through a  $1.5k\Omega$  resistor.

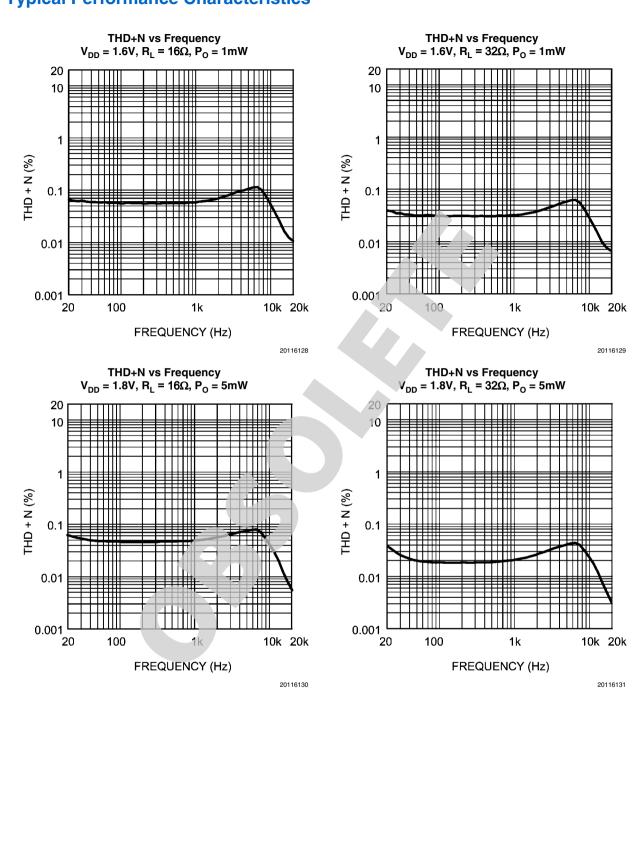
Note 11: 01A value is measured with the device mounted on a PCB with a 3" x 1.5", 1oz copper heatsink.

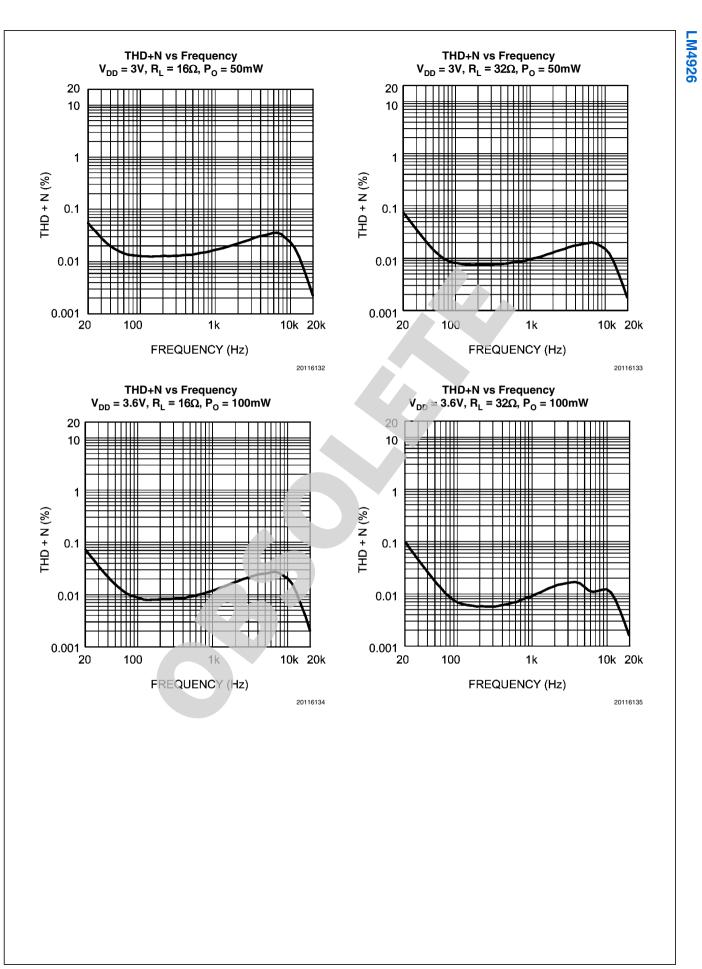
### **External Components Description**

#### (Figure 1)

Components		Functional Description		
1.	Ci	Input coupling capacitor which blocks the DC voltage at the amplifier's input terminals. Also creates a high-pass filter with $R_i$ at $f_c = 1/(2\pi R_i C_i)$ . Refer to the section <b>Proper Selection of External Components</b> , for an explanation of how to determine the value of $C_i$ .		
2.	C <sub>1</sub>	Flying capacitor. Low ESR ceramic capacitor (≤100mΩ)		
3.	C <sub>2</sub>	Output capacitor. Low ESR ceramic capacitor (≤100mΩ)		
4.	C <sub>3</sub>	Tantalum capacitor. Supply bypass capacitor which provides power supply filtering. Refer to the Power Supply Bypassing section for information concerning proper placement and selection of the supply bypass capacitor.		
5.	C <sub>4</sub>	Ceramic capacitor. Supply bypass capacitor which provides power supply filtering. Refer to the Power Supply Bypassing section for information concerning proper placement and selection of the supply bypass capacitor.		

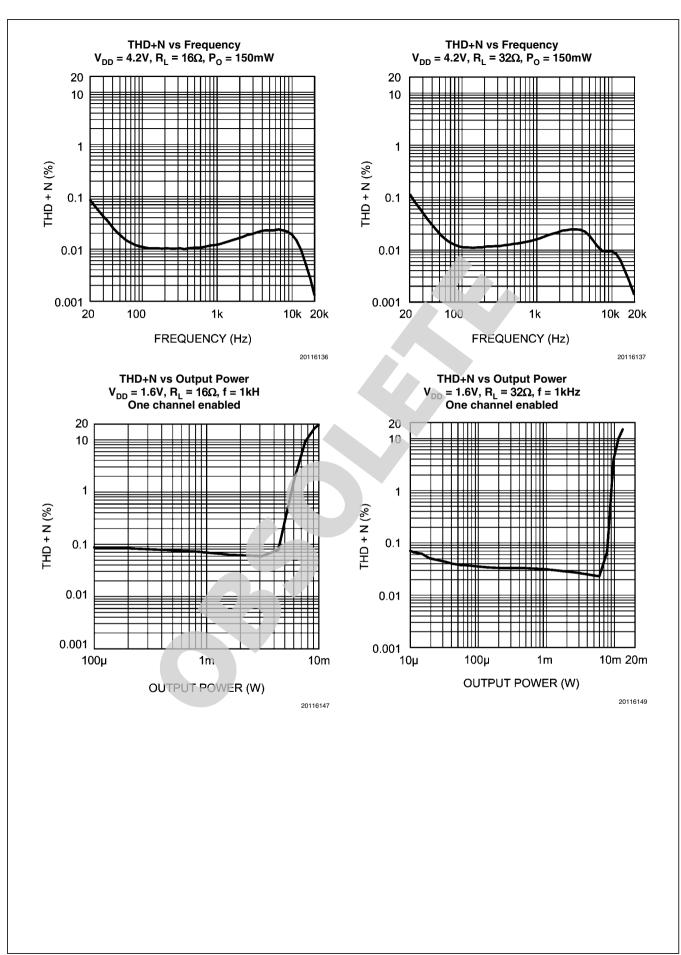
# **Typical Performance Characteristics**

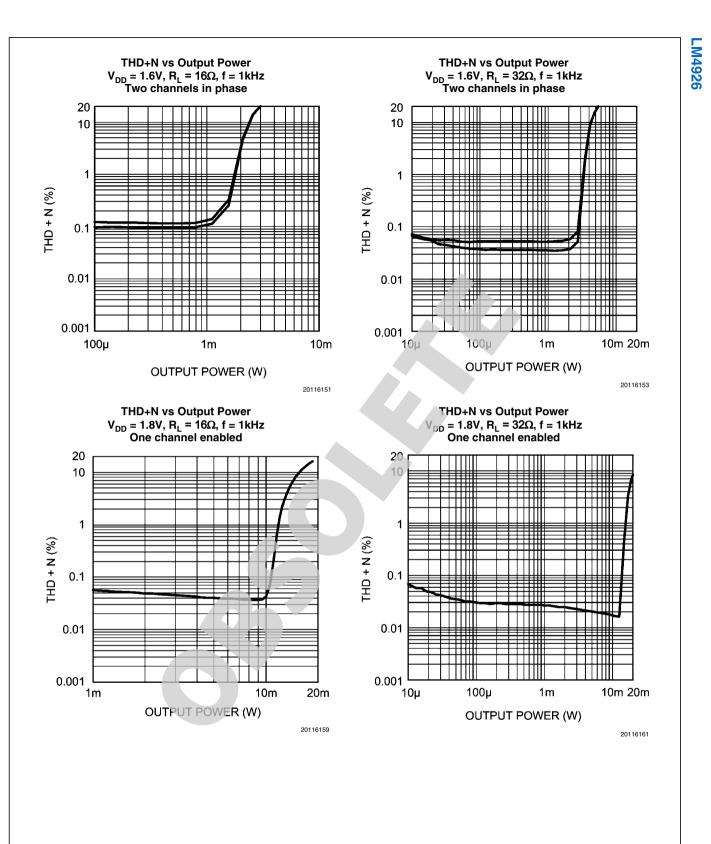


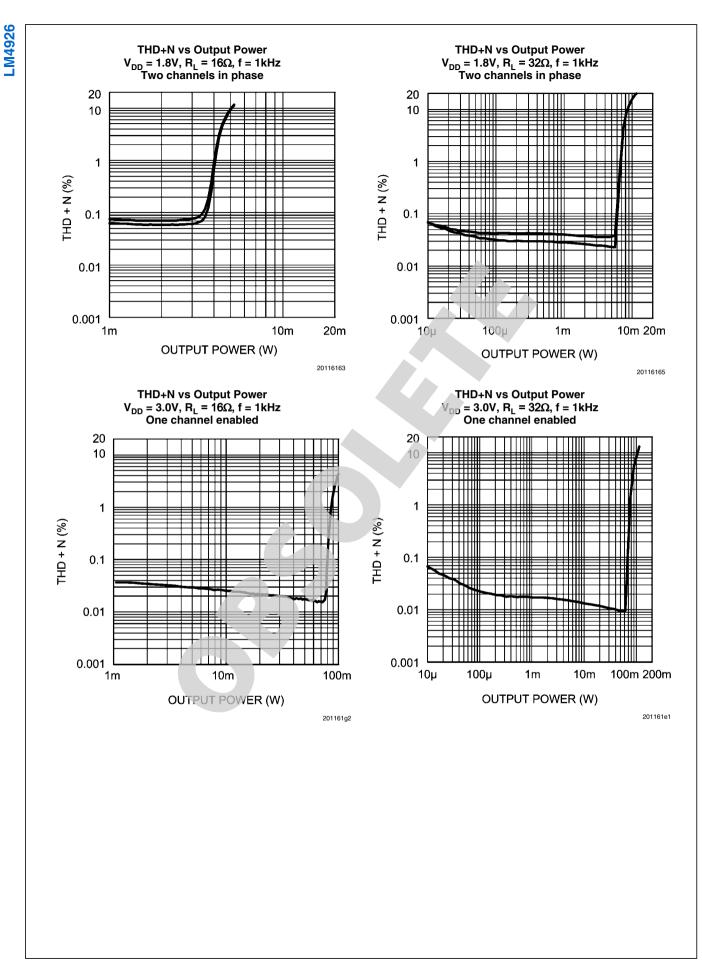


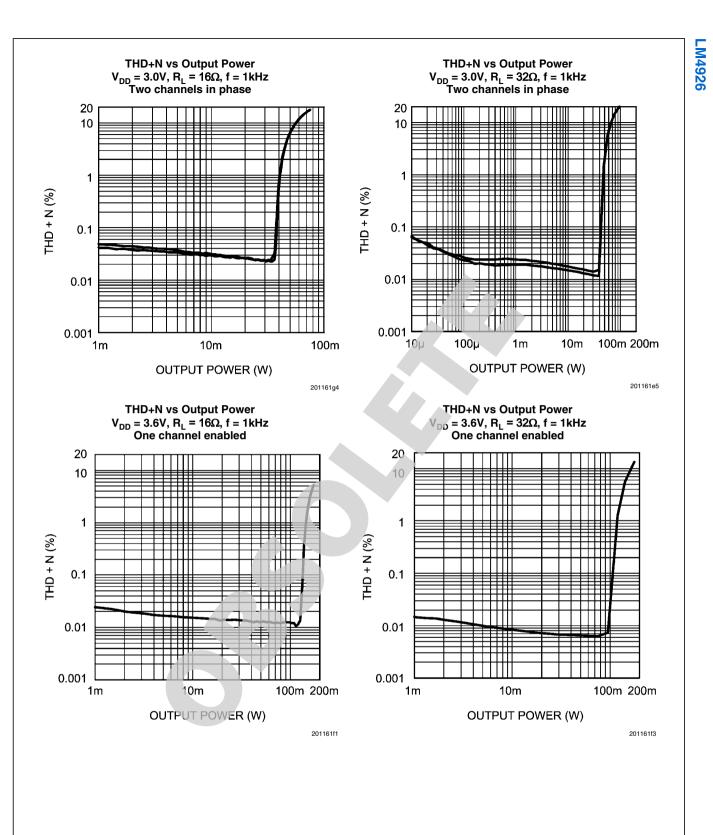
7

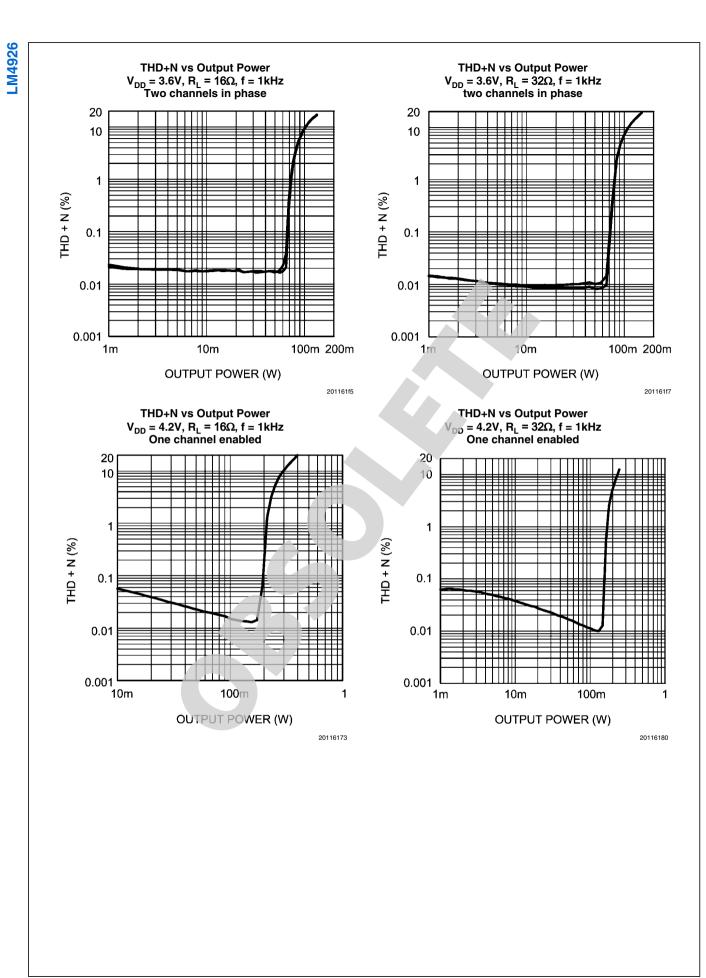


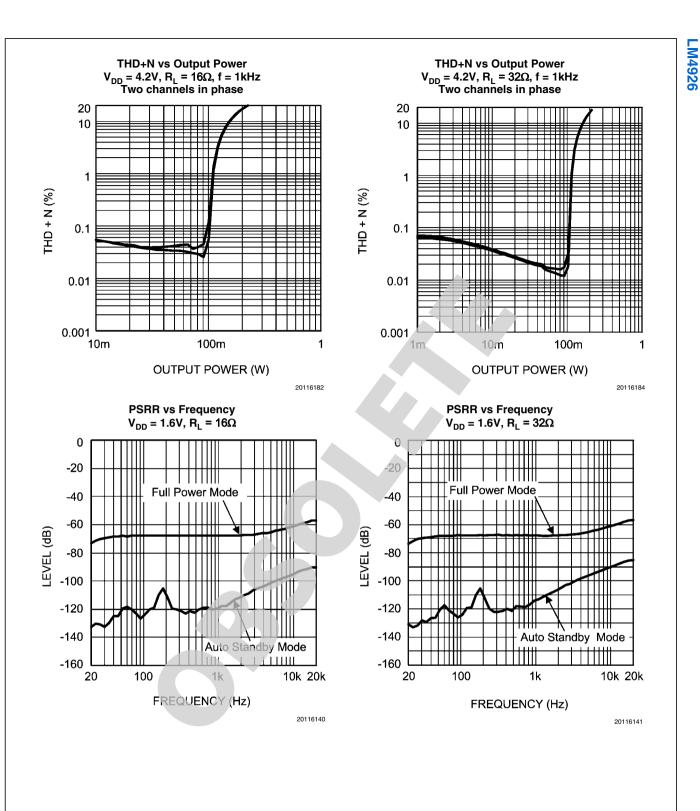


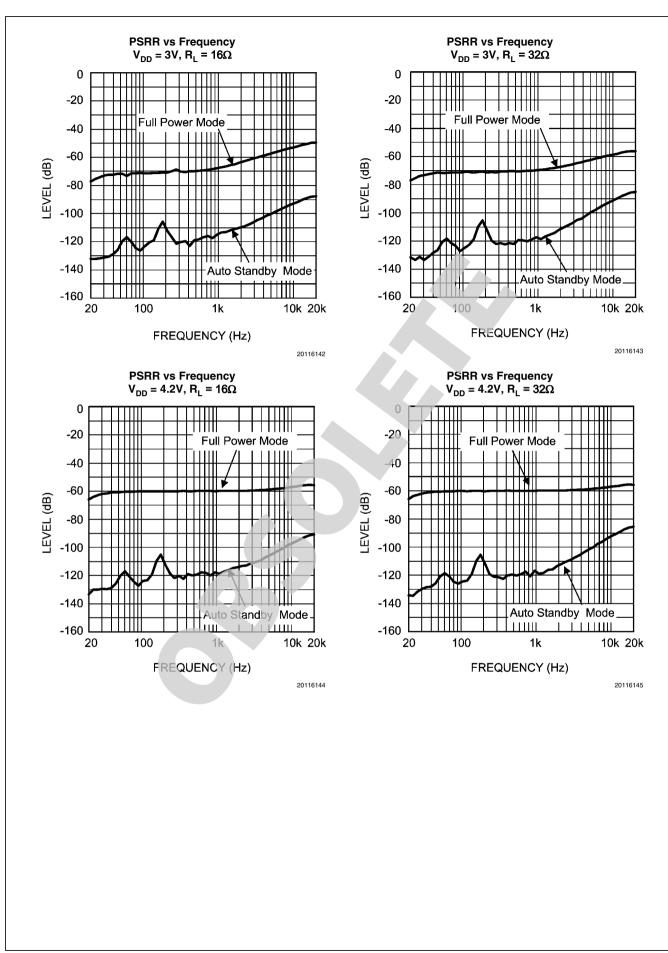


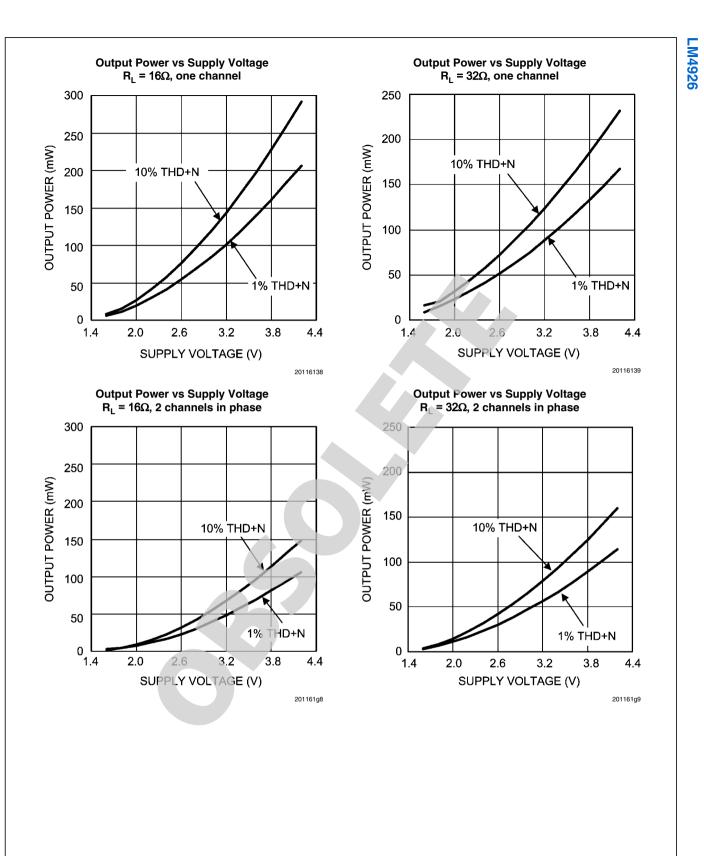




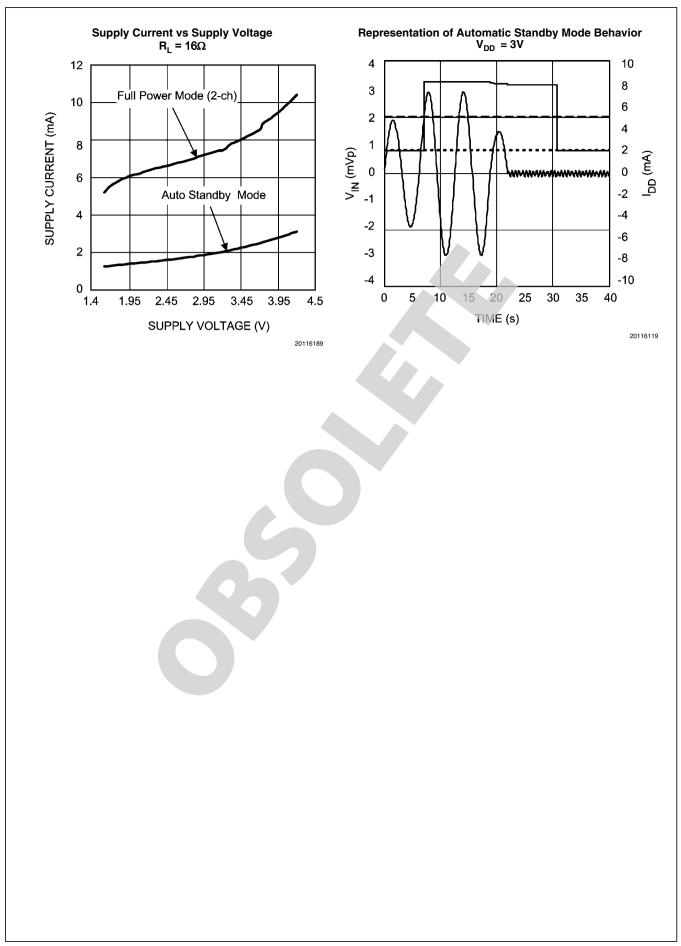












### **Application Information**

#### SUPPLY VOLTAGE SEQUENCING

It is a good general practice to first apply the supply voltage to a CMOS device before any other signal or supply on other pins. This is also true for the LM4926 audio amplifier which is a CMOS device.

Before applying any signal to the inputs or shutdown pins of the LM4926, it is important to apply a supply voltage to the  $V_{DD}$  pins. After the device has been powered, signals may be applied to the shutdown pins (see MICRO POWER SHUT-DOWN) and input pins.

#### ELIMINATING THE OUTPUT COUPLING CAPACITOR

The LM4926 features a low noise inverting charge pump that generates an internal negative supply voltage. This allows the outputs of the LM4926 to be biased about GND instead of a nominal DC voltage, like traditional headphone amplifiers. Because there is no DC component, the large DC blocking capacitors (typically 220µF) are not necessary. The coupling capacitors are replaced by two, small ceramic charge pump capacitors, saving board space and cost.

Eliminating the output coupling capacitors also improves low frequency response. In traditional headphone amplifiers, the headphone impedance and the output capacitor form a high pass filter that not only blocks the DC component of the output, but also attenuates low frequencies, impacting the bass response. Because the LM4926 does not require the output coupling capacitors, the low frequency response of the device is not degraded by external components.

In addition to eliminating the output coupling capacitors, the ground referenced output nearly doubles the available dynamic range of the LM4926 when compared to a traditional headphone amplifier operating from the same supply voltage.

#### **OUTPUT TRANSIENT ('CLICK AND POPS') ELIMINATED**

The LM4926 contains advanced circuitry that virtually eliminates output transients ('clicks and pops'). This circuitry prevents all traces of transients when the supply voltage is first applied or when the part resumes operation after coming out of shutdown mode.

#### **AMPLIFIER CONFIGURATION EXPLANATION**

As shown in Figure 2, the LM4926 has two internal operational amplifiers. The two amplifiers have internally configured gain, the closed loop gain is set by selecting the ratio of  $R_f$  to  $R_i$ . Consequently, the gain for each channel of the IC is

$$A_{V} = -(R_{f} / R_{i}) = 1.5 V/V$$

where  $R_F = 30k\Omega$  and  $R_i = 20k\Omega$ .

Since this is an output ground-referenced amplifier, by driving the headphone through  $R_{OUT}$  (Pin C2) and  $L_{OUT}$  (Pin D2), the LM4926 does not require output coupling capacitors. The typical single-ended amplifier configuration requires large, expensive output capacitors.

#### **POWER DISSIPATION**

Power dissipation is a major concern when using any power amplifier and must be thoroughly understood to ensure a successful design. Equation 1 states the maximum power dissipation point for a single-ended amplifier operating at a given supply voltage and driving a specified output load.

$$P_{DMAX} = (V_{DD})^2 / (2\pi^2 R_L)$$

(1)

Since the LM4926 has two operational amplifiers in one package, the maximum internal power dissipation point is twice that of the number which results from Equation 1. Even with large internal power dissipation, the LM4926 does not require heat sinking over a large range of ambient temperatures. From Equation 1, assuming a 3V power supply and a 16 $\Omega$  load, the maximum power dissipation point is 28mW per amplifier. Thus the maximum package dissipation point is 56mW. The maximum power dissipation point obtained must not be greater than the power dissipation that results from Equation 2:

$$P_{DMAX} = (T_{JMAX} - T_A) / (\theta_{JA})$$
(2)

For the micro SMD package,  $\theta_{JA} = 105^{\circ}$ C/W.  $T_{JMAX} = 150^{\circ}$ C for the LM4926. Depending on the ambient temperature,  $T_A$ , of the system surroundings, Equation 2 can be used to find the maximum internal power dissipation supported by the IC packaging. If the result of Equation 1 is greater than that of Equation 2, the left the supply voltage must be decreased, the load impedance increased or  $T_A$  reduced. For the typical application of a 3V power supply, with a 16 $\Omega$  load, the maximum ambient temperature possible without violating the maximum junction temperature is approximately 144°C provided that device operation is a function of output power and thus, if typical operation is not around the maximum power dissipation point, the ambient temperature may be increased accordingly.

#### POWER SUPPLY BYPASSING

As with any power amplifier, proper supply bypassing is critical for low noise performance and high power supply rejection. Applications that employ a 3V power supply typically use a  $4.7\mu$ F capacitor in parallel with a  $0.1\mu$ F ceramic filter capacitor to stabilize the power supply's output, reduce noise on the supply line, and improve the supply's transient response. Keep the length of leads and traces that connect capacitors between the LM4926's power supply pin and ground as short as possible.

#### AUTOMATIC STANDBY MODE

The LM4926 features Automatic Standby Mode circuitry (patent pending). In the absence of an input signal, after approximately 12 seconds, the LM4926 goes into low current standby mode. The LM4926 recovers into full power operating mode immediately after a signal, which is greater than the input threshold voltage, is applied to either the left or right input pins. The input threshold voltage is not a static value, as the supply voltage increases, the input threshold voltage decreases. This feature reduces power supply current consumption in battery operated applications. Please see also the graph entitled Representation of Automatic Standby Mode Behavior in the Typical Performance Characteristics section.

To ensure correct operation of Automatic Standby Mode, proper layout techniques should be implemented. Separating PGND and SGND can help reduce noise entering the LM4926 in noisy environments. Auto Standby mode works best when output impedance of the audio source driving LM4926 is equal or less than 50 Ohms. While Automatic Standby Mode reduces power consumption very effectively during silent periods, maximum power saving is achieved by putting the device into shutdown when it is not in use.

#### **MICRO POWER SHUTDOWN**

The voltage applied to the  $\overline{SD\_LC}$  (shutdown left channel) pin and the  $\overline{SD\_RC}$  (shutdown right channel) pin controls the LM4926's shutdown function. When active, the LM4926's micropower shutdown feature turns off the amplifiers' bias circuitry, reducing the supply current. The trigger point is  $0.3^*CPV_{DD}$  for a logic-low level, and  $0.7^*CPV_{DD}$  for logic-high level. The low  $0.01\mu A$  (typ) shutdown current is achieved by applying a voltage that is as near as ground a possible to the  $\overline{SD\_LC/SD\_RC}$  pins. A voltage that is higher than ground may increase the shutdown current.

There are a few ways to control the micro-power shutdown. These include using a single-pole, single-throw switch, a microprocessor, or a microcontroller. When using a switch, connect an external 100k $\Omega$  pull-up resistor between the SD\_LC/SD\_RC pins and V<sub>DD</sub>. Connect the switch between the SD\_LC/SD\_RC pins and ground. Select normal amplifier operation by opening the switch. Closing the switch connects the SD\_LC/SD\_RC pins to ground, activating micro-power shutdown. The switch and resistor guarantee that the SD\_LC/SD\_RC pins will not float. This prevents unwanted state changes. In a system with a microprocessor or micro-controller, use a digital output to apply the control voltage to the SD\_LC/SD\_RC pins. Driving the SD\_LC/SD\_RC pins with active circuitry eliminates the pull-up resistor.

#### SELECTING PROPER EXTERNAL COMPONENTS

Optimizing the LM4926's performance requires properly selecting external components. Though the LM4926 operates well when using external components with wide tolerances, best performance is achieved by optimizing component values.

#### **Charge Pump Capacitor Selection**

Use low ESR (equivalent series resistance) (<100m $\Omega$ ) ceramic capacitors with an X7R dielectric for best performance. Low ESR capacitors keep the charge pump output impedance to a minimum, extending the headroom on the negative supply. Higher ESR capacitors result in reduced output power from the audio amplifiers.

Charge pump load regulation and output impedance are affected by the value of the flying capacitor (C1). A larger valued C1 (up to 3.3uF) improves load regulation and minimizes

charge pump output resistance. Beyond 3.3uF, the switch-on resistance dominates the output impedance for capacitor values above 2.2uF.

The output ripple is affected by the value and ESR of the output capacitor (C2). Larger capacitors reduce output ripple on the negative power supply. Lower ESR capacitors minimize the output ripple and reduce the output impedance of the charge pump.

The LM4926 charge pump design is optimized for 2.2uF, low ESR, ceramic, flying, and output capacitors.

#### Input Capacitor Value Selection

Amplifying the lowest audio frequencies requires high value input coupling capacitors ( $C_i$  in Figure 1). A high value capacitor can be expensive and may compromise space efficiency in portable designs. In many cases, however, the speakers used in portable systems, whether internal or external, have little ability to reproduce signals below 150Hz. Applications using speakers with this limited frequency response reap little improvement by using high value input and output capacitors.

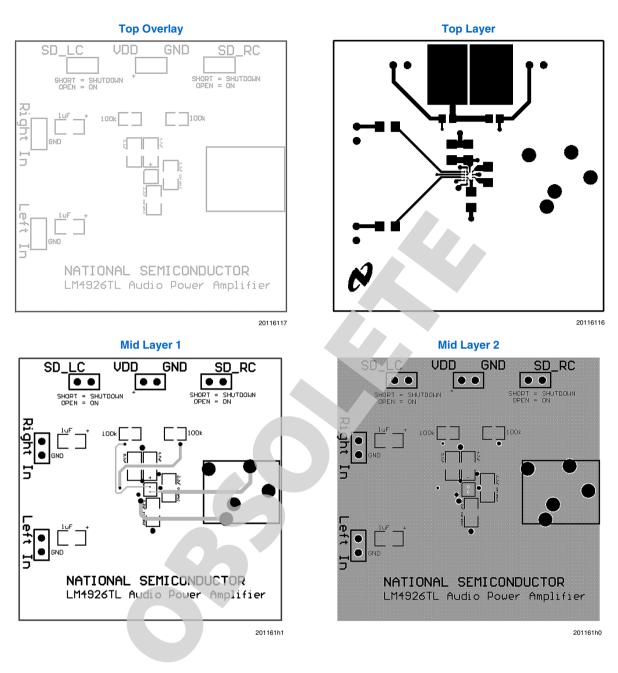
Besides affecting system cost and size,  $C_i$  has an effect on the LM4926's click and pop performance. The magnitude of the pop is directly proportional to the input capacitor's size. Thus, pops can be minimized by selecting an input capacitor value that is no higher than necessary to meet the desired -3dB frequency.

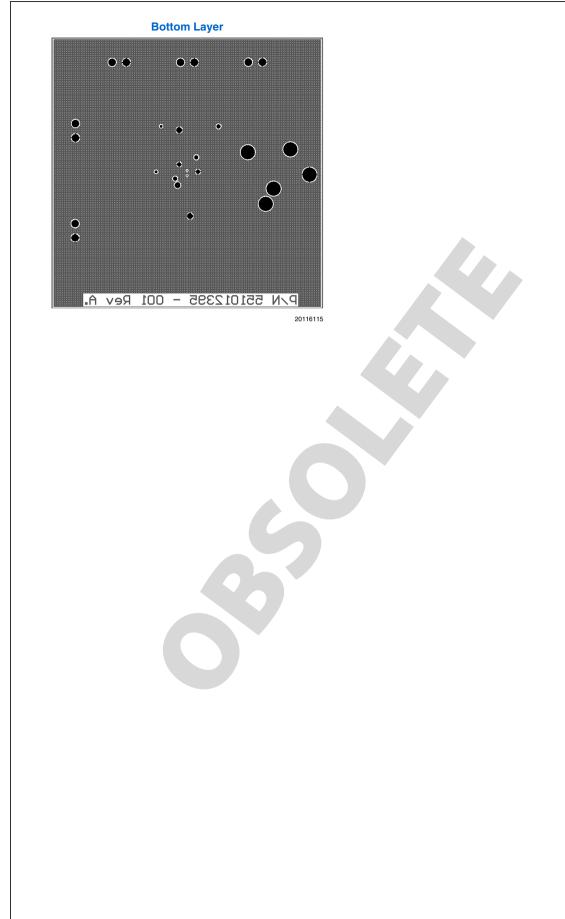
As shown in Figure 1, the internal input resistor,  $R_i$  and the input capacitor,  $C_i$ , produce a -3dB high pass filter cutoff frequency that is found using Equation (3). Conventional headphone amplifiers require output capacitors; Equation (3) can be used, along with the value of  $R_L$ , to determine towards the value of output capacitor needed to produce a –3dB high pass filter cutoff frequency.

$$f_{i-3dB} = 1 / 2\pi R_i C_i$$
 (3)

Also, careful consideration must be taken in selecting a certain type of capacitor to be used in the system. Different types of capacitors (tantalum, electrolytic, ceramic) have unique performance characteristics and may affect overall system performance. (See the section entitled Charge Pump Capacitor Selection.)

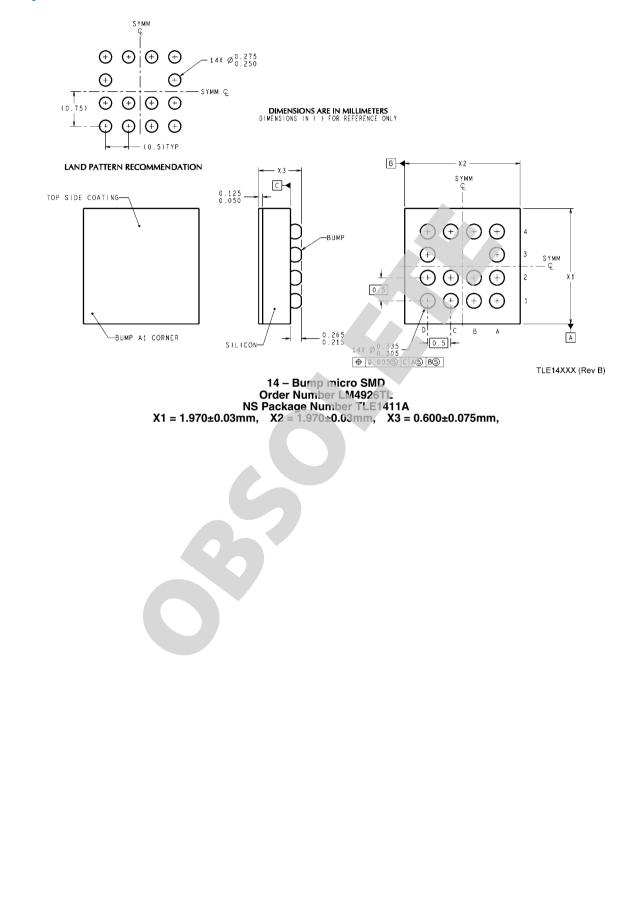
#### LM4926 micro SMD DEMO BOARD ARTWORK

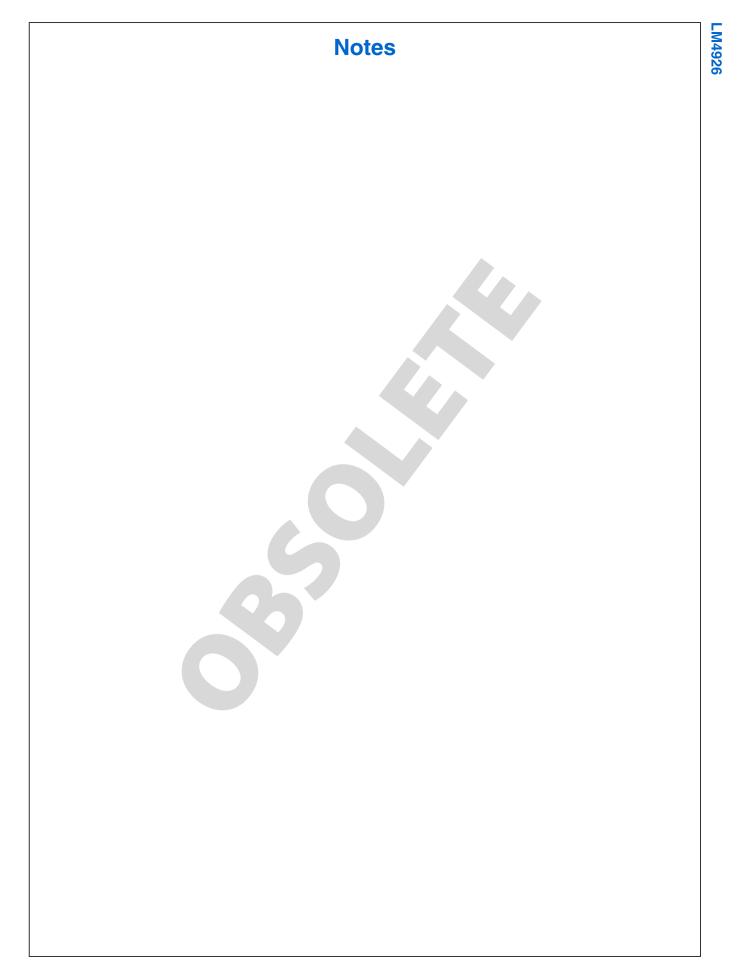




ev	Date	Description
0	6/22/05	Initial WEB release.
1	6/24/05	Added Mid Layer 1 and Mid Layer 2 boards, then re-released D/S to the WEB (per Nisha P.)

# Physical Dimensions inches (millimeters) unless otherwise noted





# **Notes**

For more National Semiconductor product information and proven design tools, visit the following Web sites at: www.national.com

Products		Design Support	
Amplifiers	www.national.com/amplifiers	WEBENCH® Tools	www.national.com/webench
Audio	www.national.com/audio	App Notes	www.national.com/appnotes
Clock and Timing	www.national.com/timing	Reference Designs	www.national.com/refdesigns
Data Converters	www.national.com/adc	Samples	www.national.com/samples
Interface	www.national.com/interface	Eval Boards	www.national.com/evalboards
LVDS	www.national.com/lvds	Packaging	www.national.com/packaging
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback
Voltage References	www.national.com/vref	Design Made Easy	www.national.com/easy
PowerWise® Solutions	www.national.com/powerwise	Applications & Markets	www.national.com/solutions
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero
Temperature Sensors	www.national.com/tempsensors	SolarMagic™	www.national.com/solarmagic
PLL/VCO	www.national.com/wireless	PowerWise® Design University	www.national.com/training

THE CONTENTS OF THIS DOCUMENT ARE PROVIDED IN CONNECTION WITH NATIONAL SEMICONDUCTOR CORPORATION ("NATIONAL") PRODUCTS. NATIONAL MAKES NO REPRESENTATIONS OR WARRANTIES WITH RESPECT TO THE ACCURACY OR COMPLETENESS OF THE CONTENTS OF THIS PUBLICATION AND RESERVES THE RIGHT TO MAKE CHANGES TO SPECIFICATIONS AND PRODUCT DESCRIPTIONS AT ANY TIME WITHOUT NOTICE. NO LICENSE, WHETHER EXPRESS, IMPLIED, ARISING BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT.

TESTING AND OTHER QUALITY CONTROLS ARE USED TO THE EXTENT NATIONAL DEEMS NECESSARY TO SUPPORT NATIONAL'S PRODUCT WARRANTY. EXCEPT WHERE MANDATED BY GOVERNMENT REQUIREMENTS, TESTING OF ALL PARAMETERS OF EACH PRODUCT IS NOT NECESSARILY PERFORMED. NATIONAL ASSUMES NO LIABILITY FOR APPLICATIONS ASSISTANCE OR BUYER PRODUCT DESIGN. BUYERS ARE RESPONSIBLE FOR THEIR PRODUCTS AND APPLICATIONS USING NATIONAL COMPONENTS, PRIOR TO USING OR DISTRIBUTING ANY PRODUCTS THAT INCLUDE NATIONAL COMPONENTS, BUYERS SHOULD PROVIDE ADEQUATE DESIGN, TESTING AND OPERATING SAFEGUARDS.

EXCEPT AS PROVIDED IN NATIONAL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS. NATIONAL ASSUMES NO LIABILITY WHATSOEVER, AND NATIONAL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY RELATING TO THE SALE AND/OR USE OF NATIONAL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

#### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS PRIOR WRITTEN APPROVAL OF THE CHIEF EXECUTIVE OFFICER AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

Life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness.

National Semiconductor and the National Semiconductor logo are registered trademarks of National Semiconductor Corporation. All other brand or product names may be trademarks or registered trademarks of their respective holders.

Copyright© 2011 National Semiconductor Corporation

For the most current product information visit us at www.national.com



M4926 Ground-Referenced. Ultra Low Noise.

Fixed Gain, 80mW Stereo Headphone Amplifier

National Semiconductor Americas Technical Support Center Email: support@nsc.com w.national.com Tel: 1-800-272-9959

National Semiconductor Europe **Technical Support Center** Email: europe.support@nsc.com

National Semiconductor Asia Pacific Technical Support Center Email: ap.support@nsc.com

National Semiconductor Japan **Technical Support Center** Email: ipn.feedback@nsc.com

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Audio	www.ti.com/audio	Communications and Telecom	www.ti.com/communications
Amplifiers	amplifier.ti.com	Computers and Peripherals	www.ti.com/computers
Data Converters	dataconverter.ti.com	Consumer Electronics	www.ti.com/consumer-apps
DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
Logic	logic.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Mobile Processors	www.ti.com/omap		
Wireless Connectivity	www.ti.com/wirelessconnectivity		
		u Hama Dawa	a O a Al a a m

**TI E2E Community Home Page** 

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2011, Texas Instruments Incorporated